

High Efficiency Fast Response, 6A, 23V Input Synchronous Step Down Regulator

General Description

The SY8286B develops a high efficiency synchronous step-down DC/DC regulator with 3.3V fixed output voltage and 6A current rating. The device integrates main switch and synchronous switch with very low $R_{DS(ON)}$ to minimize the conduction loss. The SY8286B also integrates a 3.3V/100mA LDO with bypass switch and individual enable control.

The SY8286B operates over a wide input voltage range from 4V to 23V. The DC/DC regulator adopts the instant PWM architecture to achieve fast transient responses for high step down applications and high efficiency at light loads. In addition, it operates at pseudo-constant frequency of 600kHz under heavy load conditions to minimize the size of inductor and capacitor.

Ordering Information

SY8286

└─ Temperature Code
└─ Package Code
└─ Optional Spec Code

Ordering Number	Package type	Note
SY8286BRAC	QFN3×3-20	--

Features

- Low $R_{DS(ON)}$ for Internal Switches (Top/Bottom): 38/19 mΩ
- Wide Input Voltage Range: 4-23V
- 3.3V LDO with Individual Enable Control and Bypass Switch
- Integrated Bypass Switch: 1.5Ω
- Instant PWM Architecture to Achieve Fast Transient Responses
- Internal 1.2ms Soft-start Limits the Inrush Current
- Pseudo-constant Frequency: 600kHz.
- 6A Output Current Capability
- +/-1.5% Output Voltage Accuracy
- Power Good Indicator
- Output Discharge Function
- Output Current Limit Protection
- Short Circuit Latch-off Protection
- Output Over Voltage Latch-off Protection
- Input UVLO
- Over Temperature Protection
- RoHS Compliant and Halogen Free
- Compact Package: QFN3×3-20

Applications

- LCD-TV/Net-TV/3DTV
- Set Top Box
- Notebook
- High Power AP

Typical Applications

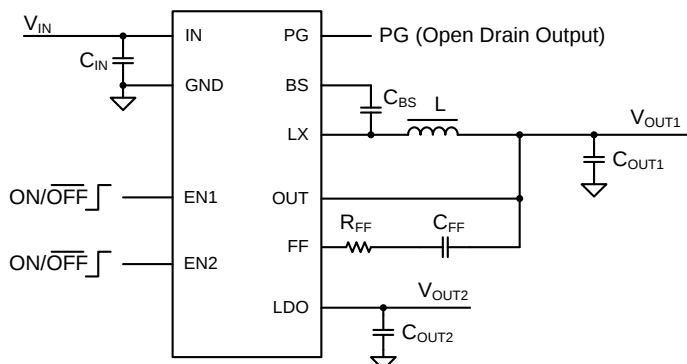


Figure1. Schematic Diagram

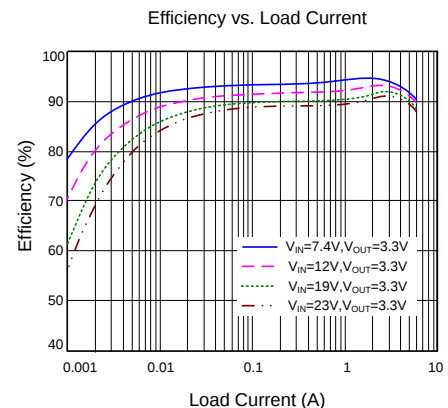
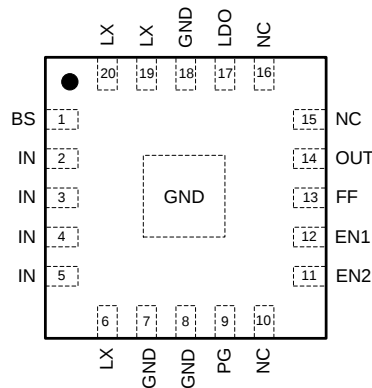


Figure 2. Efficiency vs. Load Current

Pinout (top view)



(QFN3×3-20)

Top Mark: AWWxyz, (Device code: AWW, x=year code, y=week code, z= lot number code)

Pin Name	Pin Number	Pin Description
BS	1	Boot-strap pin. Supply high side gate driver. Decouple this pin to the LX pin with a 0.1μF ceramic capacitor.
IN	2,3,4,5	Input pin. Decouple this pin to the GND pin with at least a10μF ceramic capacitor.
LX	6,19,20	Inductor pin. Connect this pin to the switching node of the inductor.
GND	7,8,18,EP	Ground pin.
PG	9	PG is an open-drain output pin. This pin is externally pulled high when the output voltage is within 90% to 120% regulation voltage range. Otherwise this pin is internally pulled low.
NC	10, 15,16	Not connected.
EN2	11	Enable control of the IC and internal LDO. Pull this pin high to turn on the IC and internal LDO. Do not leave this pin floating.
EN1	12	Enable control of the DC/DC regulator. Pull this pin high to turn on the regulator. Do not leave this pin floating.
FF	13	Output feed forward pin. Connect an RC network from the output to this pin.
OUT	14	Output pin. Connect to the output of the DC/DC regulator. The pin also provides the bypass input for the internal LDO.
LDO	17	3.3V LDO output. Decouple this pin to the ground with at least a 4.7uF capacitor.

Block Diagram

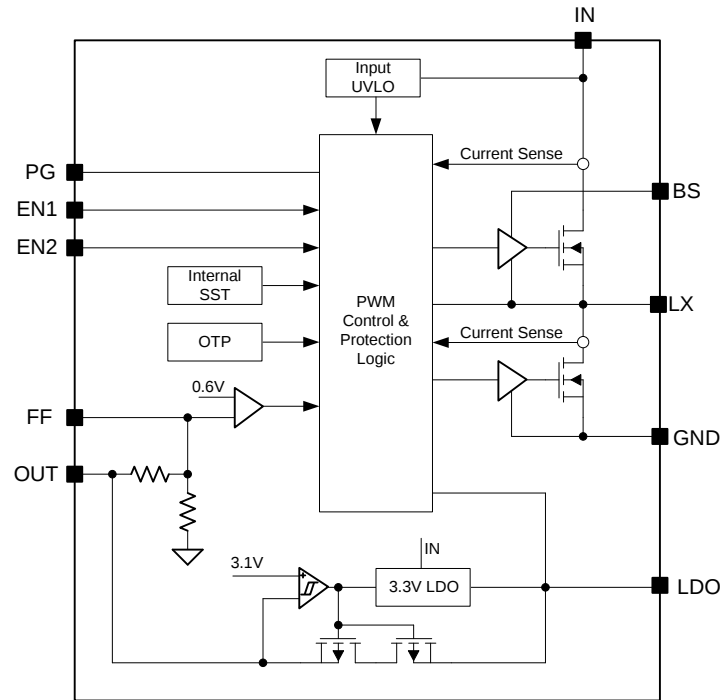


Figure3. Block Diagram

Absolute Maximum Ratings (Note 1)

IN, LX, PG	25V
BS-LX	4V
EN1, EN2	25V
LDO	4V
OUT	6V
FF	6V
Power Dissipation,	
P_D @ $T_A = 25^\circ\text{C}$, QFN3×3-20	3.3W
Package Thermal Resistance (Note 2)	
θ_{JA} , QFN3×3-20	30 $^\circ\text{C}/\text{W}$
θ_{JC} , QFN3×3-20	4.5 $^\circ\text{C}/\text{W}$
Junction Temperature Range	150 $^\circ\text{C}$
Lead Temperature (Soldering, 10 sec.)	260 $^\circ\text{C}$
Storage Temperature Range	-65 $^\circ\text{C}$ to 150 $^\circ\text{C}$
Dynamic LX Voltage in 10ns Duration	IN+3V to GND-5V

Recommended Operating Conditions (Note 3)

Supply Input Voltage	4V to 23V
Junction Temperature Range	-40 $^\circ\text{C}$ to 125 $^\circ\text{C}$
Ambient Temperature Range	-40 $^\circ\text{C}$ to 85 $^\circ\text{C}$

Electrical Characteristics

($V_{IN} = 12V$, $C_{OUT} = 100\mu F$, $T_A = 25^\circ C$, $I_{OUT} = 1A$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{IN}		4.0		23	V
Quiescent Current	I_Q	$I_{OUT}=0$, $V_{OUT}=V_{SET}\times 105\%$		75	90	μA
Shutdown Current 1	I_{SHDN1}	EN1=0, EN2=1			70	μA
Shutdown Current 2	I_{SHDN2}	EN1=0, EN2=0		6	10	μA
Output Voltage Set-point	V_{SET}		3.319	3.37	3.421	V
Top FET RON	$R_{DS(ON)1}$			38		m Ω
Bottom FET RON	$R_{DS(ON)2}$			19		m Ω
Output Discharge Current	I_{DIS}			70		mA
HSFET FET Current Limit	$I_{LMT,HSFET}$		12			A
Bottom FET Current Limit	$I_{LMT,LSFET}$		8			A
Soft-start Time	T_{SS}			1.2		ms
EN Rising Threshold	V_{ENH}		1			V
EN Falling Threshold	V_{ENL}				0.4	V
Input UVLO Threshold	V_{UVLO}				3.9	V
UVLO Hysteresis	V_{HYS}			0.2		V
Switching Frequency	f_{OSC}		510	600	690	kHz
Min ON Time	$t_{ON,MIN}$	$V_{IN}=V_{INMAX}$		50		ns
Min OFF Time	$t_{OFF,MIN}$			150		ns
Output Over Voltage Threshold		V_{OUT} rising	115	120	125	$\%V_{SET}$
Output Over Voltage Hysteresis				5		$\%V_{SET}$
Output OVP Delay				20		μs
Output Under Voltage Protection Threshold			55	60	65	$\%V_{SET}$
Output UVP Delay				200		μs
Power Good Threshold		V_{OUT} rising (Good)	87.5	92.5	97.5	$\%V_{SET}$
Power Good Hysteresis				2		$\%V_{SET}$
Power Good Delay		Low to high		200		μs
		High to low		10		μs
LDO Output Voltage	V_{LDO}	$V_{IN}=12V$, No load	3.201	3.3	3.399	V
LDO Dropout Voltage	$V_{DROPOUT}$	$I_{LDO}=100mA$		200		mV
LDO Output Current Limit	I_{LMTLDO}		150		300	mA
Bypass Switch RON	R_{BYP}			1.5		Ω
Bypass Switch Turn-on Voltage	V_{BYP}		2.97	3.1		V
Bypass Switch Switchover Hysteresis				0.2		V
Bypass Switch OVP				120		$\%V_{LDO}$
Thermal Shutdown Temperature	T_{SD}			150		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYS}			15		$^\circ C$



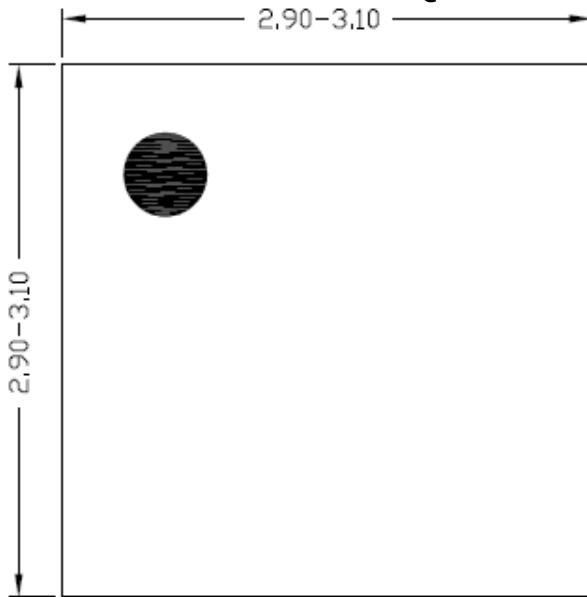
SY8286B

Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

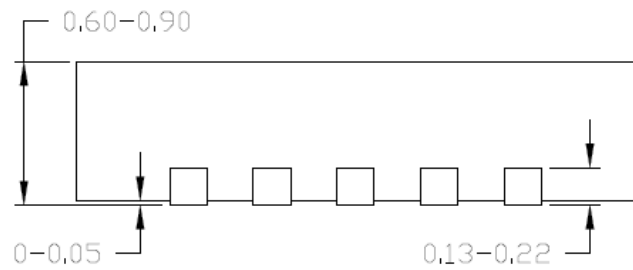
Note 2: θ_{JA} is measured in the natural convection at $T_A = 25\text{ }^{\circ}\text{C}$ on a four-layer Silergy evaluation board.

Note 3: The device is not guaranteed to function outside its operating conditions.

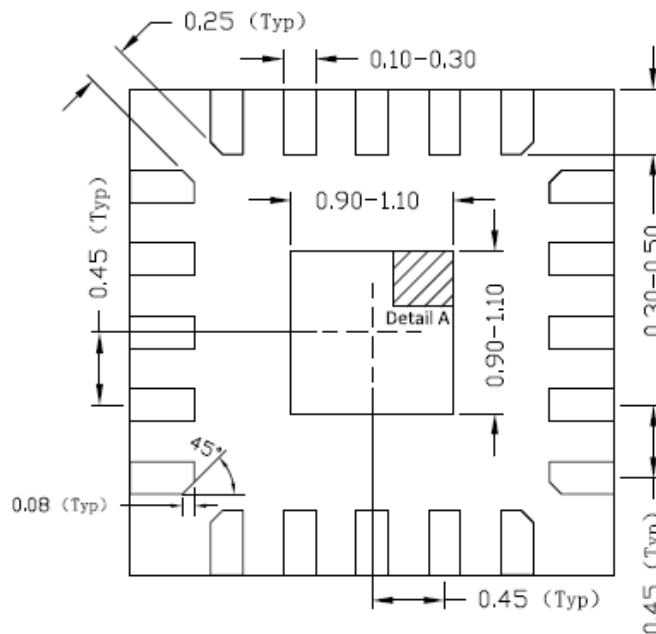
QFN3×3-20 Package Outline



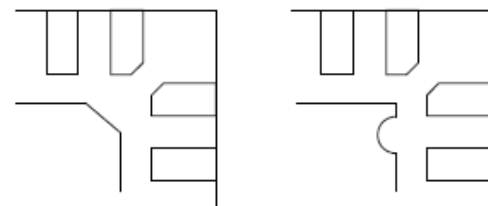
Top view



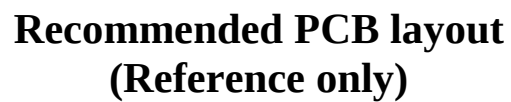
Side view



Bottom view



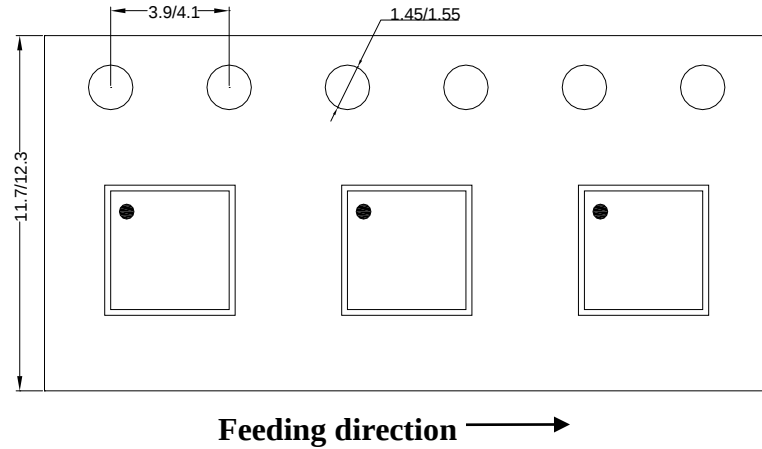
Detail A
Pin1 Identifier: two options



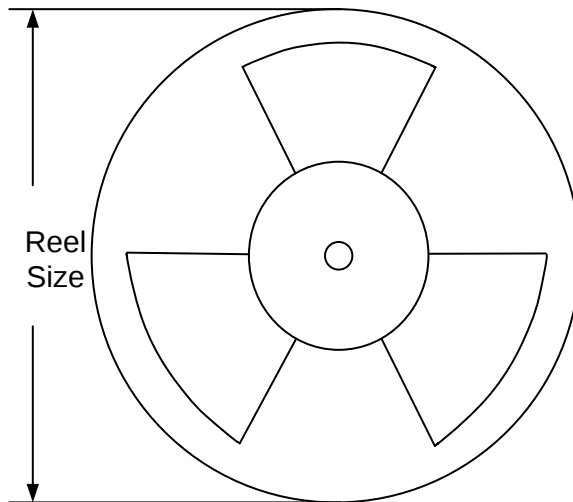
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Taping & Reel Specification

1. QFN3×3-20 taping orientation



2. Carrier Tape & Reel specification for packages



Package types	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
QFN3×3	12	8	13"	400	400	5000

3. Others: NA



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